

TECHNICAL DATASHEET AFTC 5332 - 0.025" THICK

PRODUCT DESCRIPTION

This product is a double sided acrylic based adhesive tape, which is especially designed to bond a wide variety of plastic substrates. This tape is capable of absorbing the differing thermal expansions of the two different materials which in plastics can be extremely high.

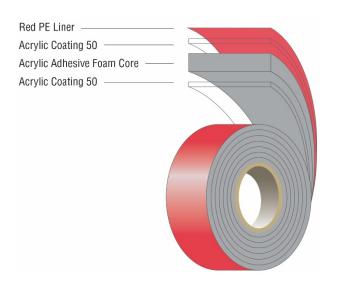
TYPICAL APPLICATIONS

Various medium and low surface energy plastics like:

- · ABS
- · ASA
- · EVA
- · PMMA
- · PS
- · PVC
- PC

PRODUCT FEATURES & BENEFITS

- Maintains a high impact resistance even at temperatures below 0 °Celsius
- UV resistant
- · Solvent resistant



TECHNICAL DATA	VALUE	TEST METHOD / STANDARD	
THICKNESS	0.025" ±15%		
COLOR	Gray		
MATERIAL / SUBSTRATE	Coated Acrylic Foam		
CORE	Acrylic Adhesive Foam Core	Acrylic Adhesive Foam Core	
ADHESIVE TYPE	Acrylic Coating 50		
ADHESIVE SYSTEM	Permanent Adhesive		
ADHESIVE SIDE	Double Sided Adhesive		
LINER	Red PE liner		
DENSITY	52 lb/ft ³		
MINIMUM TEMPERATURE RESISTANCE	-40°F		
SHORT-TERM TEMPERATURE RESISTANCE	320°F		
LONG-TERM TEMPERATURE RESISTANCE	212°F		
90° PEEL ADHESION	20 lb/in	ASTM D3330	
DYNAMIC SHEAR STRENGTH	101 lb/in ²	ASTM D1002	
TENSILE STRENGTH	107 lb/in ²	ASTM D897	
STATIC SHEAR STRENGTH @ 72°F	1,500 grams*	ASTM 3654	
STATIC SHEAR STRENGTH @ 150°F	500 grams*	ASTM 3654	
CELL STRUCTURE	Closed Cell		
SOLVENT RESISTANCE	Excellent		
UV RESISTANCE	Excellent		

Specifications are believed to be accurate at the time of publication and are subject to change without notice. It is the responsibility of the end-user to test and determine suitability of this material for a particular application. **REV. 0**



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RECOMMENDED APPLICATION TEMPERATURE	Minimum 59°F	
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NOTES: *Weight that 1/2 square inch will hold 10,000 minutes (7 days).

SHELF LIFE/STORAGE		
SHELF LIFE	18 months	
RECOMMENDED STORAGE CONDITIONS	Store in its original package and in a dry place between 39.2°F and 100.4°F	

CLEANING

To clean your light and medium contaminated substrates, use an isopropanol/alcohol solution (IPA). When cleaning your substrate, a tear free, light colored paper towel is required. Wipe the substrate in one direction using the one cloth method (one cloth with cleaner) or a two-cloth method (one cloth with cleaner and one dry cloth to follow) is acceptable if you are short on time. Repeat these steps until your cloth is clean and free of any contaminants. For heavily contaminated substrates, use a cleaning agent such as MEK, Heptan or Acetone. These cleaning agents may leave a residue which would have to be removed using the IPA cleaner.

ABRASION

When bonding to raw aluminum, abrading of the surface is a must. The oils used in the waltzing of the aluminum are pressed into the pores of the material. To remove these oils, that will influence the bond, we recommend using abrasive pads to ensure the proper level of abrasion without damaging your substrates. Besides raw aluminum, abrading is a method utilized to help improve your bond. After the abrasion process is completed, remove any residue using an IPA cleaner following the methods mentioned above.

PRIMER

The use of a primer is recommended when bonding to some low surface energy substrates. Examples include, different types of polymers, powder coated metals, or porous materials such as wood, cork, stone or concrete. Primers are also used to help speed up your production process. The AFTC line can take up to 72 hours to reach its end-strength. The use of a primer ensures the end-strength will be achieved within 20 minutes.

H-O Products offers two primers; the primer 33 and the primer 101. Determining which one of these primers is suitable for your application ultimately depends on the substrates and environmental influences.

PRESSURE

AFTC tapes are pressure sensitive adhesives. Therefore, a minimum amount of pressure is required on the bond line to ensure the maximum adhesion to your substrates. This pressure should be applied in a rolling fashion. A hand roller or mechanical presser are the preferred methods. The pressure on the bond line must be a minimum of at least 14.5 psi.